Power MOSFET and Schottky Diode

-20 V, -4.1 Å, P-Channel, with 2.0 A Schottky Barrier Diode, 2x2 mm, μCool™ Package

Features

- FETKY™ Configuration with MOSFET plus Low Vf Schottky Diode
- µCOOL™ Package Provides Exposed Drain Pad for Excellent Thermal Conduction
- 2x2 mm Footprint Same as SC-88 Package Design
- Independent Pinout Provides Circuit Design Flexibility
- Low Profile (< 0.8 mm) for Easy Fit in Thin Environment
- High Current Schottky Diode: 2 A Current Rating
- This is a Pb-Free Device

Applications

- Optimized for Portable Applications like Cell Phones, Digital Cameras, Media Players, etc.
- DC-DC Buck Circuit
- Li-Ion Battery Applications
- Color Display and Camera Flash Regulators

MAXIMUM RATINGS (T_{.1} = 25°C unless otherwise noted)

Param	eter		Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	-20	V		
Gate-to-Source Voltage)		V_{GS}	±8.0	V
Continuous Drain	Steady	T _A = 25°C	I _D	-3.3	Α
Current (Note 1)	State	T _A = 85°C		-2.4	
	t ≤ 5 s	T _A = 25°C		-4.1	
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	1.5	W
	t ≤ 5 s	.,		2.3	
Continuous Drain		T _A = 25°C	I _D	-2.3	Α
Current (Note 2)	Steady	T _A = 85°C		-1.6	
Power Dissipation (Note 2)	State	T _A = 25°C	P _D	0.71	W
Pulsed Drain Current	t _p =	10 μs	I_{DM}	-20	Α
Operating Junction and	T _J , T _{STG}	-55 to 150	°C		
Source Current (Body D	I _S	-1.9	Α		
Lead Temperature for So (1/8" from case for 10 s)	TL	260	°C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
- Surface Mounted on FR4 Board using the minimum recommended pad size of 30 mm², 2 oz Cu.



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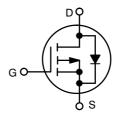
http://onsemi.com

MOSFET

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX (Note 1)
	100 mΩ @ -4.5 V	
-20 V	135 mΩ @ -2.5 V	-4.1 A
	200 mΩ @ -1.8 V	

SCHOTTKY DIODE

V _R MAX	V _F TYP	I _F MAX
30 V	0.47 V	2.0 A





P-CHANNEL MOSFET

SCHOTTKY DIODE



WDFN6 CASE 506AN

MARKING DIAGRAM



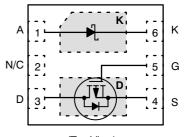
JH = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



(Top View)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

SCHOTTKY DIODE MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	30	V
DC Blocking Voltage	V _R	30	V
Average Rectified Forward Current	I _F	2.0	Α

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 3)	$R_{ hetaJA}$	83	
Junction-to-Ambient – $t \le 5 s$ (Note 3)	$R_{ hetaJA}$	54	°C/W
Junction-to-Ambient - Steady State Min Pad (Note 4)	$R_{\theta JA}$	177	

- Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).
 Surface Mounted on FR4 Board using the minimum recommended pad size of 30 mm², 2 oz Cu.

$\textbf{MOSFET ELECTRICAL CHARACTERISTICS} \ (T_J = 25^{\circ}\text{C unless otherwise noted})$

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = -25	60 μΑ	-20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = -250 μA, Ref to	25°C		9.95		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	101/1/	T _J = 25°C			-1.0	μΑ
		$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$	T _J = 85°C			-10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±	8.0 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = -25$	50 μA	-0.4	-0.7	-1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.44		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	$V_{GS} = -4.5, I_D = -2$	2.0 A		75	100	mΩ
		$V_{GS} = -2.5, I_D = -2.5$	2.0 A		101	135	
		V _{GS} = -1.8, I _D = -1.6 A			150	200	
Forward Transconductance	9FS	V _{DS} = -5.0 V, I _D = -2.0 A			3.1		S
CHARGES, CAPACITANCES AND GA	TE RESISTAN	CE					
Input Capacitance	C _{ISS}				531		pF
Output Capacitance	C _{OSS}	$V_{GS} = 0 \text{ V, f} = 1.0 \text{ N}$ $V_{DS} = -10 \text{ V}$	ЛHz,		91		
Reverse Transfer Capacitance	C _{RSS}	103			56		
Total Gate Charge	Q _{G(TOT)}				5.5	6.2	nC
Threshold Gate Charge	Q _{G(TH)}				0.7		
Gate-to-Source Charge	Q_{GS}	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$ $I_D = -2.0 \text{ A}$			1.0		
Gate-to-Drain Charge	Q_{GD}	.g = 2.670			1.4		
Gate Resistance	R_{G}				8.8		Ω
SWITCHING CHARACTERISTICS (No	ote 6)						
Turn-On Delay Time	t _{d(ON)}				5.2		ns
Rise Time	t _r	V _{GS} = -4.5 V, V _{DD} = -	-5.0 V,		13.2		
Turn-Off Delay Time	t _{d(OFF)}	$I_D = -1.0 \text{ A}, R_G = 6.0 \Omega$			13.7		
					•		

Fall Time

5. Pulse Test: Pulse Width $\leq 300~\mu s$, Duty Cycle $\leq 2\%$.
6. Switching characteristics are independent of operating junction temperatures.

19.1

MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25$ °C unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS	(Note 6)						
Turn-On Delay Time	t _{d(ON)}				5.5		ns
Rise Time	t _r	$V_{GS} = -4.5 \text{ V}, V_{DD} = -10 \text{ V},$ $I_{D} = -2.0 \text{ A}, R_{G} = 2.0 \Omega$			15		
Turn-Off Delay Time	t _{d(OFF)}				19.8		
Fall Time	t _f				21.6		
DRAIN-SOURCE DIODE CHARA	CTERISTICS						
Forward Recovery Voltage	V _{SD}	V 0V/IC 10A	$T_J = 25^{\circ}C$		-0.75	-1.0	V
		V _{GS} = 0 V, IS = -1.0 A	$V_{GS} = 0 \text{ V, IS} = -1.0 \text{ A}$ $T_{J} = 125^{\circ}\text{C}$		-0.64		V
Reverse Recovery Time	t _{RR}				16.2		
Charge Time	t _a	$V_{GS} = 0 \text{ V, } d_{ SD}/d_t = 100 \text{ A/}\mu\text{s,}$ $I_S = -1.0 \text{ A}$			10.6		ns
Discharge Time	t _b				5.6		

nC

5.7

Reverse Recovery Time

SCHOTTKY DIODE ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Instantaneous	V _F	I _F = 0.1 A		0.34	0.39	V
Forward Voltage		I _F = 1.0 A		0.47	0.53	
Maximum Instantaneous	I _R	V _R = 30 V		17	20	μΑ
Reverse Current		V _R = 20 V		3.0	8.0	
		V _R = 10 V		2.0	4.5	

SCHOTTKY DIODE ELECTRICAL CHARACTERISTICS ($T_J = 85^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Instantaneous	V _F	I _F = 0.1 A		0.22	0.35	V
Forward Voltage		I _F = 1.0 A		0.40	0.50	
Maximum Instantaneous	I _R	V _R = 30 V		0.22	2.5	mA
Reverse Current		V _R = 20 V		0.11	1.6	
		V _R = 10 V		0.06	1.2	

SCHOTTKY DIODE ELECTRICAL CHARACTERISTICS (T_J = 125°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Maximum Instantaneous	V _F	I _F = 0.1 A		0.2	0.29	V
Forward Voltage		I _F = 1.0 A		0.4	0.47	
Maximum Instantaneous	I _R	V _R = 30 V		2.0	20	mA
Reverse Current		V _R = 20 V		1.1	10.9	
		V _R = 10 V		0.63	8.4	

SCHOTTKY DIODE ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Ī	Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
I	Capacitance	O	$V_R = 5.0 \text{ V}, f = 1.0 \text{ MHz}$		38		pF

^{7.} Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).

^{5.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.

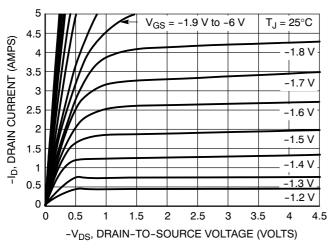
^{6.} Switching characteristics are independent of operating junction temperatures.

^{8.} Surface-mounted on FR4 board using the minimum recommended pad size of 30 mm², 2 oz cu.

^{9.} Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

^{10.} Switching characteristics are independent of operating junction temperatures.

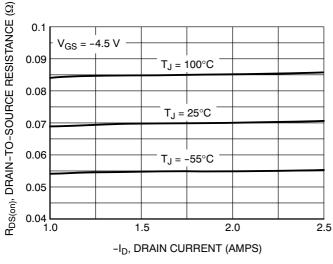
TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



5 V_{DS} ≥ 10 V 4 3 3 2 T_J = 25°C T_J = -55°C 0 0.5 1 1.5 2 2.5 3 -V_{GS}, GATE-TO-SOURCE VOLTAGE (VOLTS)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



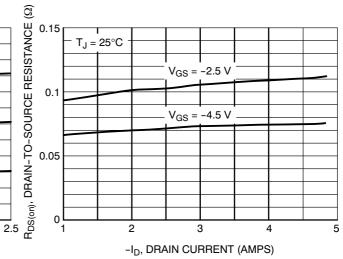
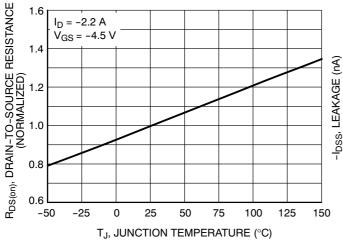


Figure 3. On-Resistance versus Drain Current

Figure 4. On-Resistance versus Drain Current and Gate Voltage



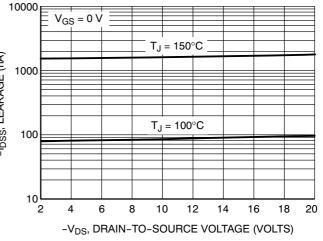
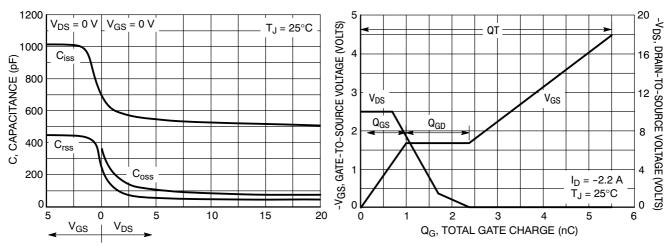


Figure 5. On-Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current versus Voltage

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 8. Gate-To-Source and Drain-To-Source
Voltage versus Total Charge



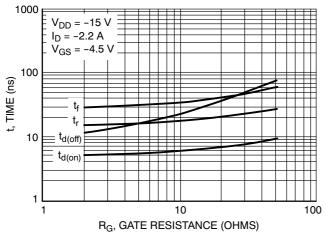


Figure 9. Resistive Switching Time Variation versus Gate Resistance

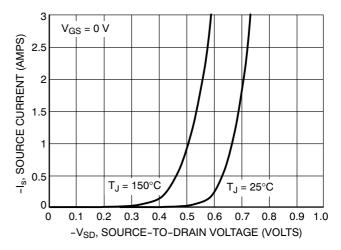


Figure 10. Diode Forward Voltage versus Current

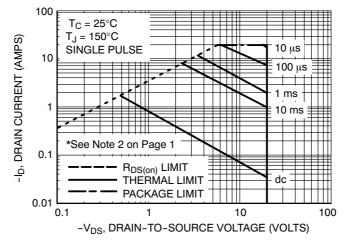


Figure 11. Maximum Rated Forward Biased Safe Operating Area

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

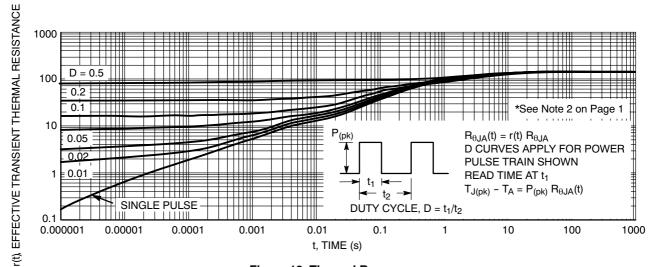
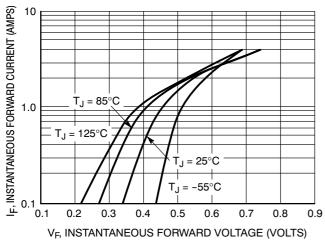


Figure 12. Thermal Response

TYPICAL SCHOTTKY PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



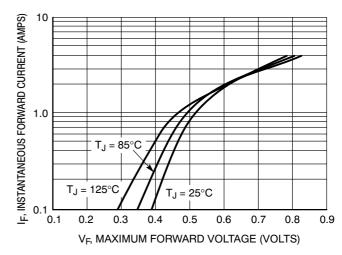


Figure 13. Typical Forward Voltage

Figure 14. Maximum Forward Voltage

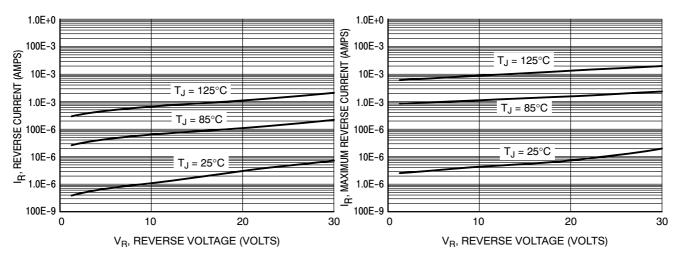


Figure 15. Typical Reverse Current

Figure 16. Maximum Reverse Current

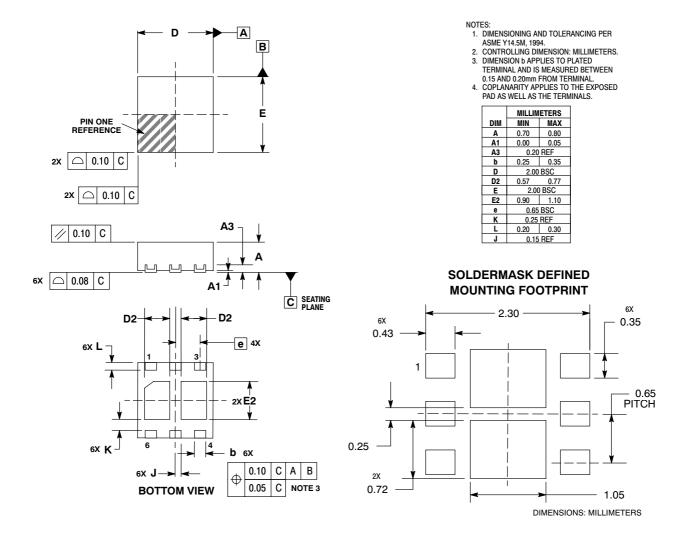
ORDERING INFORMATION

Device	Package	Shipping [†]
NTLJF3117PT1G	WDFN6 (Pb-Free)	3000 / Tape & Reel
NTLJF3117PTAG	WDFN6 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

WDFN6 2x2 CASE 506AN-01 ISSUE C



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